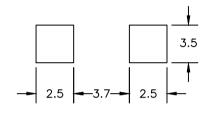
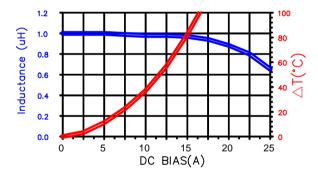
MGV06031R0M-10

PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	±	0.30
С	3.00	±	0.30
D	2.90	±	0.30
Ε	1.60	\pm	0.50

LAND PATTERNS FOR REFLOW SOLDERING

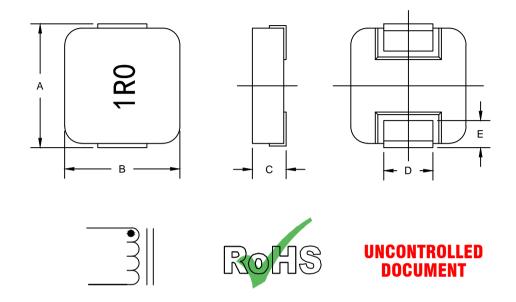




ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	0.8	1.0	1.2
DCR (Ω)			0.010

Saturation Current ³ Isat (A)	22
Temperature Rise Current Irms ⁴ (A)	11



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS $\leq 25\%$ FROM ITS VALUE WITHOUT CURRENT (Ta=25 \pm 5°C).
- 4.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm.			This print is the property of Laird						
				Tech, and is loaned in confidence subject to return upon request a with the understanding that no	ind	Laird			
				copies shall be made without the written consent of Laird Tech. All	ı	Land			
				rights to design or invention are reserved.					
				PROJECT/PART NUMBER:	1		PART TY		DRAWN BY:
С	UPDATE LOGO	04/22/15	QIU	MGV06031R0M-10		C		WER CTOR	QIU
В	CHANGE NOTE 2.3.4	09/24/12	ä	DATE: 06/27/12	CALE	- N	re	SHEET:	
Α	ORIGINAL DRAFT	06/27/12	QIU	, ,	OOL		13		
REV	DESCRIPTION	DATE	INT			-	-	1	of 1